

16TH TOPICAL SEMINAR ON INNOVATIVE PARTICLE AND RADIATION DETECTORS (IPRD23)

# HASPIDE: A PROJECT FOR THE DEVELOPMENT OF HYDROGENATED AMORPHOUS SILICON RADIATION SENSORS ON A FLEXIBLE SUBSTRATE

# SUMMARY

- ▶ INTRODUCTION
- ▶ PRO-CON AND POSSIBLE APPLICATIONS
- ▶ PERFORMANCES
- ▶ CONCLUSIONS

# Hydrogenated Amorphous Silicon (A-Si:H)

- **Amorphous**

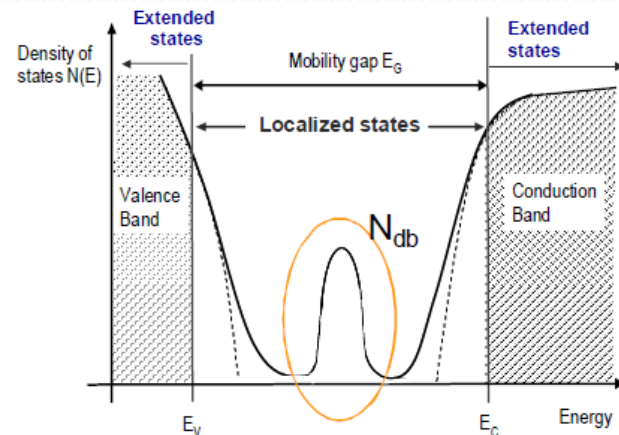
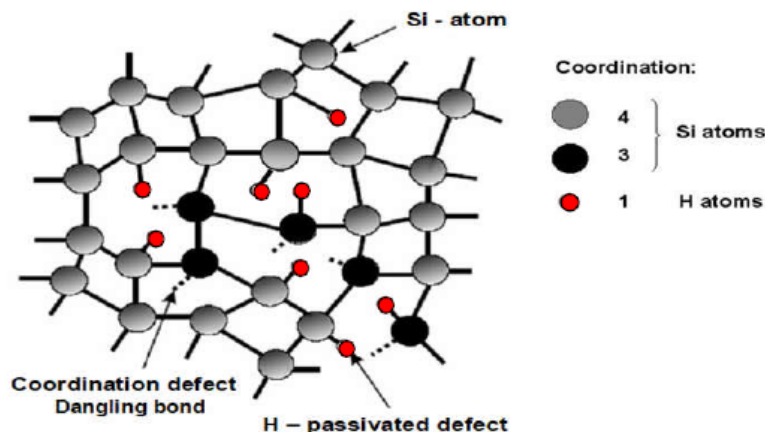
- **Order in the disorder** (short range order, ~ nm)
- Disorder due the presence of di-vacancies
- Disorder leads to localized states in gap

Coordination **defects**  $\rightarrow$  ~ mid-gap states  
 Dangling bond, density  $N_{db}$  (recombination centers)

Fluctuations in Si-Si bond  $\rightarrow$  **Band tails (traps)**  
 Weak bonds

- **Hydrogenated**

Passivation of dangling bonds by H  
 $a\text{-Si} \rightarrow a\text{-Si:H} : N_{db} : 10^{19} \text{ cm}^{-3} \rightarrow 10^{15} \text{ cm}^{-3}$



# A-Si:H as radiation detector material pros & cons

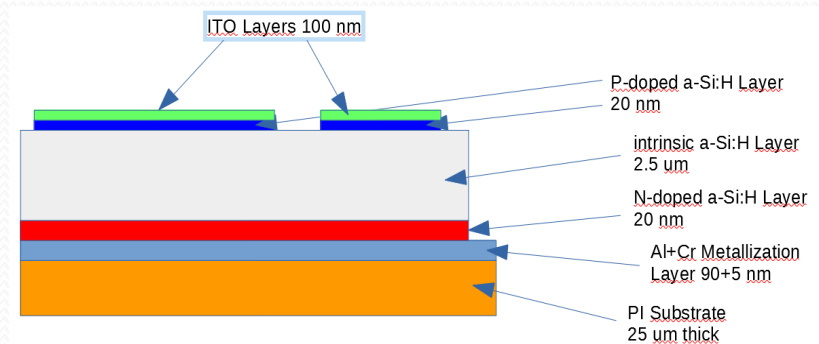
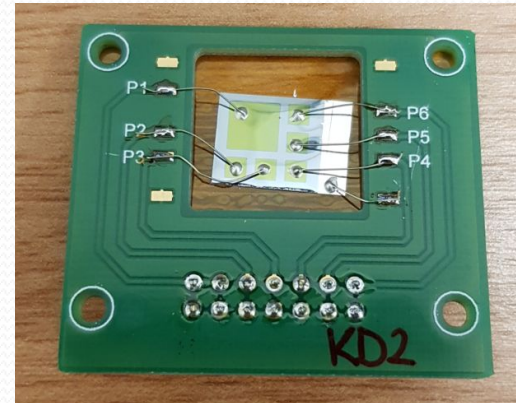
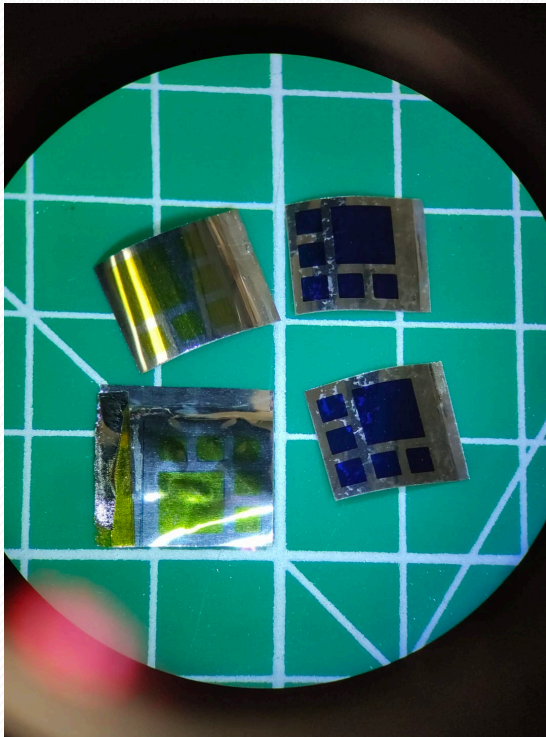
- Pros:

- Extremely low radiation damage.
- Low cost production.
- Possible deposition in many different substrate materials
- Good flexibility below 15  $\mu\text{m}$
- Photosensitive: usable in photodiode fabrication

- Cons:

- High depletion voltage (about 1100 V for 50  $\mu\text{m}$  thickness)
- Growth on a non-removable substrate
- Maximum processing temperature 250-300  $^{\circ}\text{C}$
- Limited thickness of substrates (max 100-150  $\mu\text{m}$ )
- Pretty low S/N ratio due to poor charge collection efficiency: below 50% (on a 30  $\mu\text{m}$  thick detector) energy to create a e-h pair similar to crystalline silicon (3.4-4.0 eV) and high leakage current (around  $\mu\text{A}/\text{cm}^2$  on a 30  $\mu\text{m}$  detector)
- Low mobility (from 1 to 10  $\text{cm}^2/\text{Vs}$  for electrons 2 orders of magnitude less for holes)

# HASPIDE prototype



- Hydrogenated Amorphous Silicon Pixels DEtectors
- On Polyimide substrate (kapton) for flexibility
- Production Array of 20 2x2 mm<sup>2</sup> p-i-n diodes and 4 5x5 mm<sup>2</sup> p-i-n diodes
- 2.5  $\mu\text{m}$  thickness

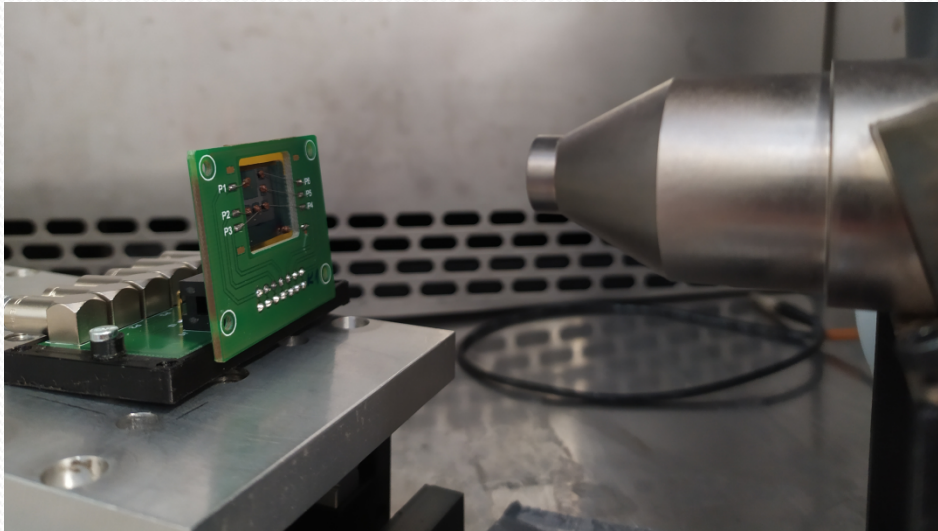
# Application as a rad-hard flexible detector

- Beam monitoring for dosimetry and beam profile (Active membrane)
- Beam dosimetry and beam profile for radiotherapy (X-rays, electrons, protons, possibly ions)
  - Possibility of dose measurement in the curved surfaces of a patient body
- Particle fluxes determination in solar events
- Thermal Neutron monitor with the addition of a Boron layer

# Detector R&D

- Two device architectures
  - Planar P-i-n diodes (most commonly used and baseline option)
  - Charge selective contacts devices ( $\text{MoO}_x$  as hole selective contact and  $\text{TiO}_2$  or  $\text{Al:ZnO}$  as electron selective contact)
- Three deposition techniques
  - PECVD (the most commonly used and baseline technique)
  - Reactive Sputtering for intrinsic silicon (in Hydrogen environment)
  - Reactive Laser Ablation (RLA) of doped and un-doped Silicon (in Hydrogen)
  - Plasma Laser Deposition (PLD) for the electrodes

# Test under X-Rays

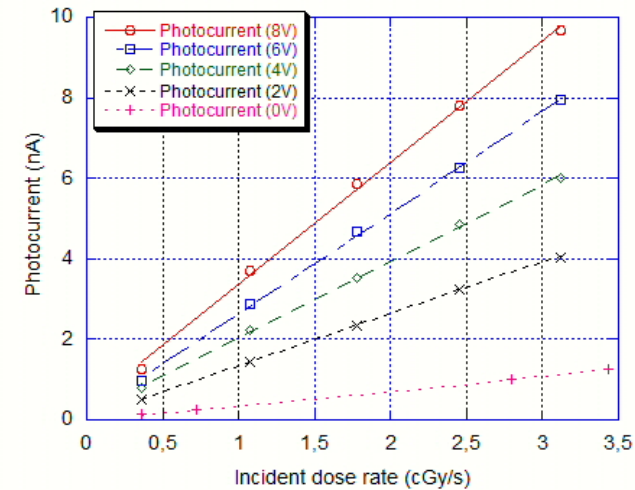
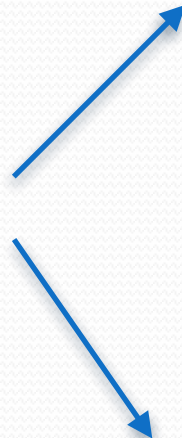
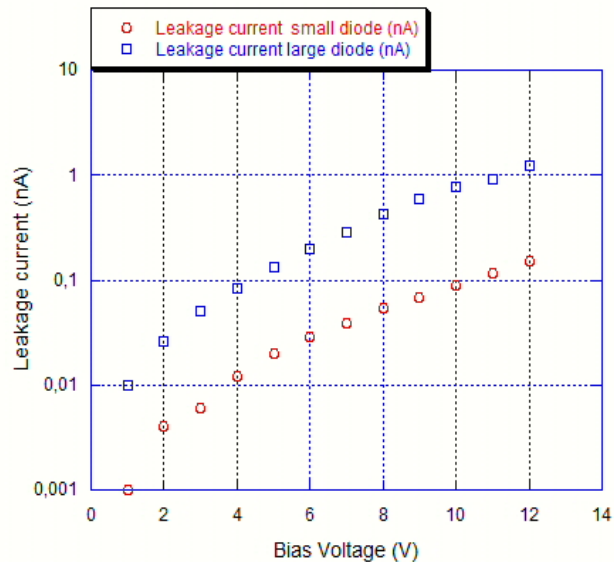


- X-ray tube 10 W by Newton scientific
- $V_{max} = 50 \text{ kV}$ ,  $I_{max} = 200 \mu\text{A}$
- Cobia Flex dosimeter using T20 probe
- Measuring range  
( $1.5 \mu\text{Gy/s}$ - $1500 \text{ mGy/s}$ )

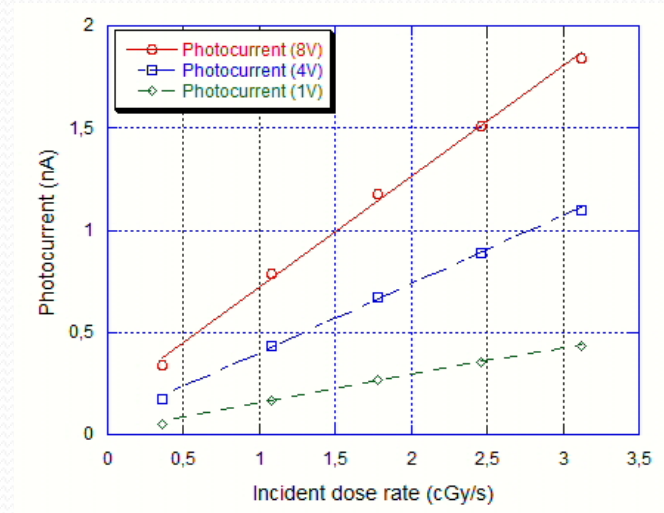




# Current response and dose rate (x-rays) linearity



Large



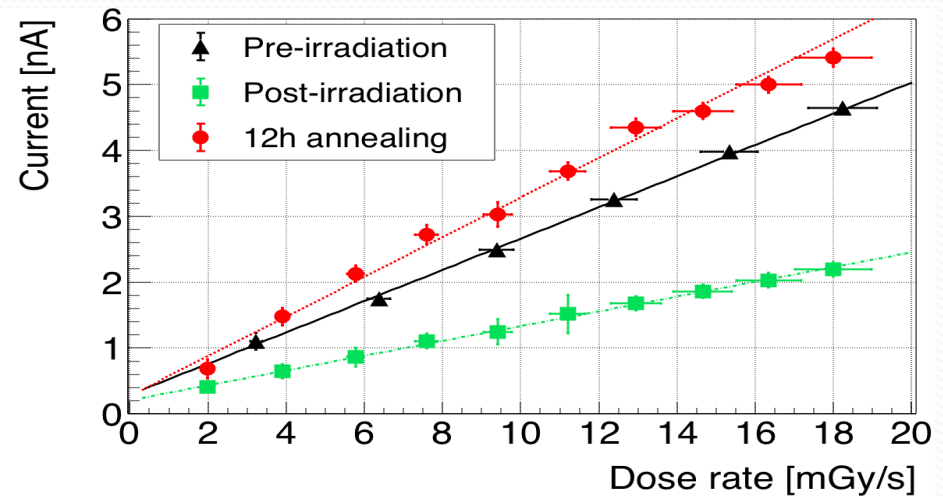
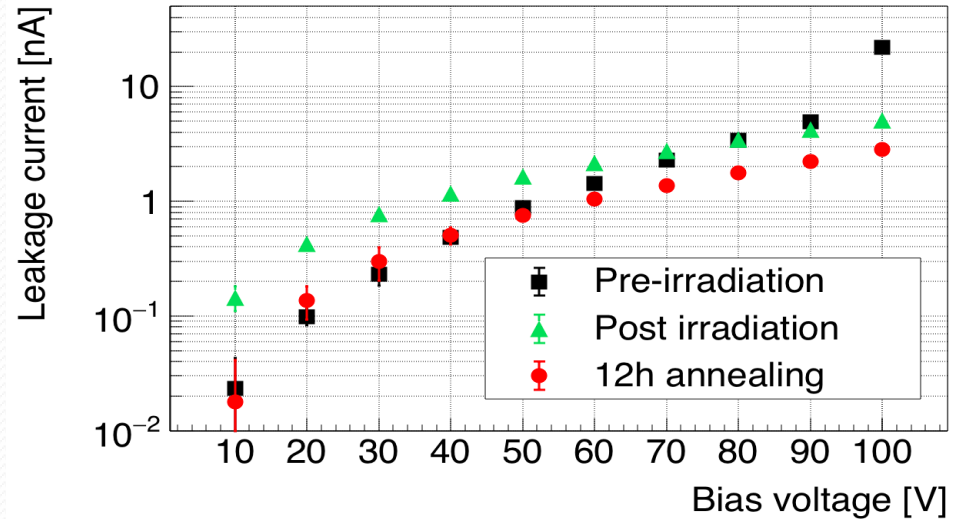
Small

- linear sensitivity
- Dependence on reverse bias voltage

# Preliminary radiation tests (c-Si)

- P-i-n deposited on c-Si
- Max Leakage current O(nA)
- Beneficial effect of the annealing procedure

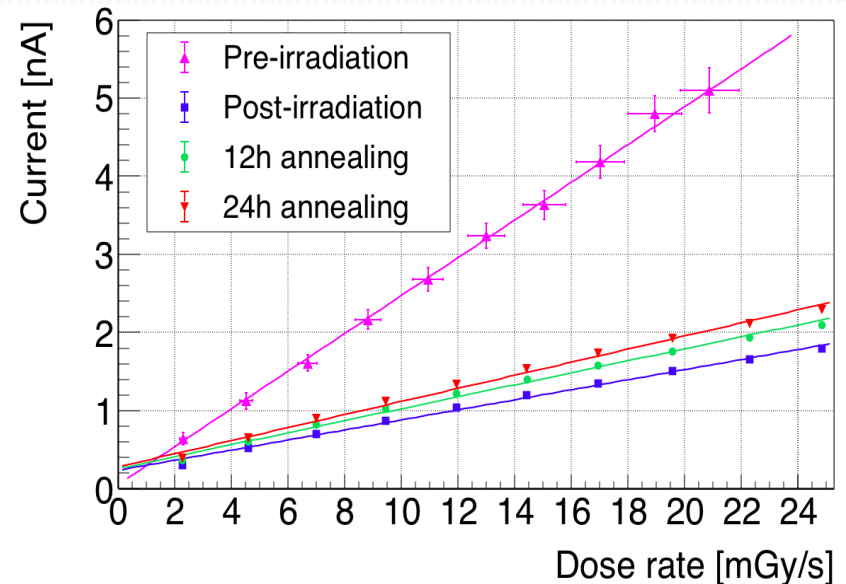
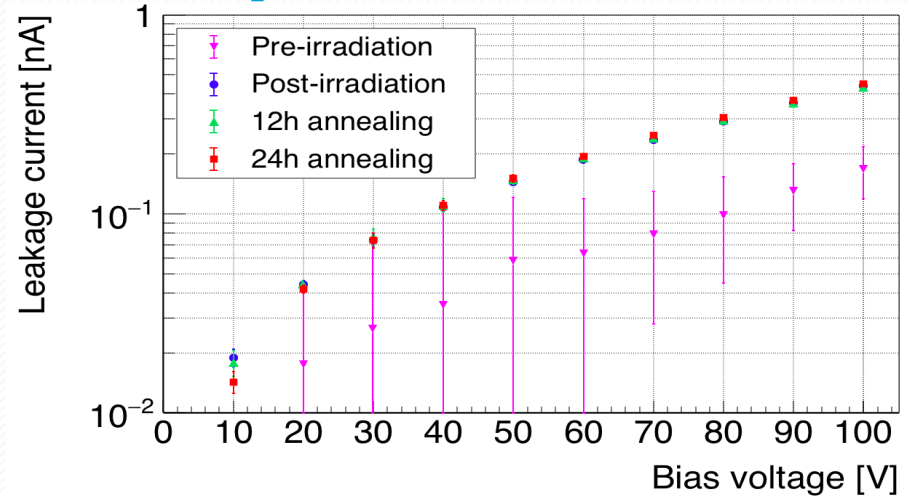
Test at  $10^{16} \text{ n}_{\text{eq}}/\text{cm}^2$



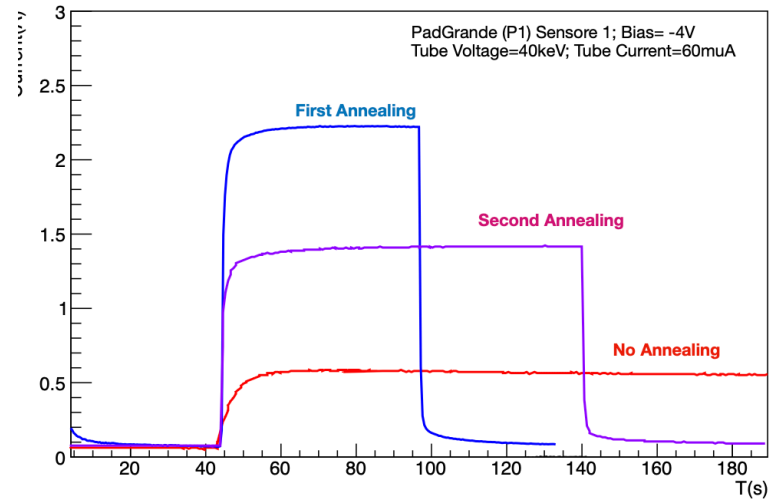
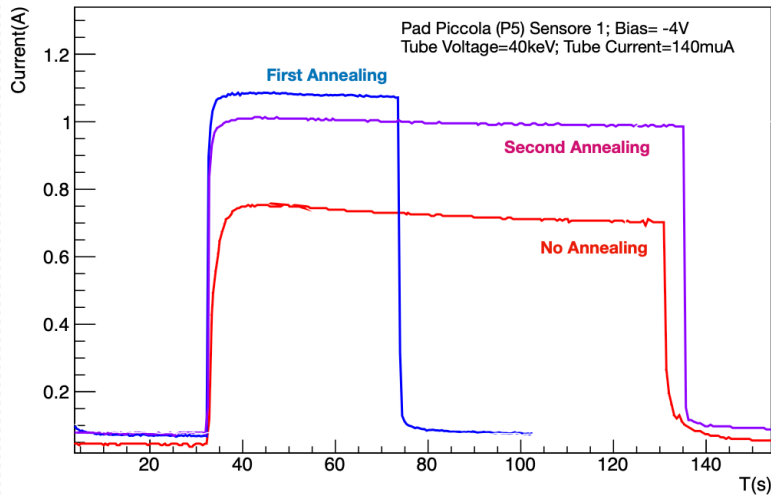
# Preliminary radiation tests (kapton)

- P-i-n deposited on kapton
- Max Leakage current  $\sim$  c-Si O(nA)
- Less effect of the annealing procedure

Test at  $5 \times 10^{16} \text{ n}_{\text{eq}} / \text{cm}^2$

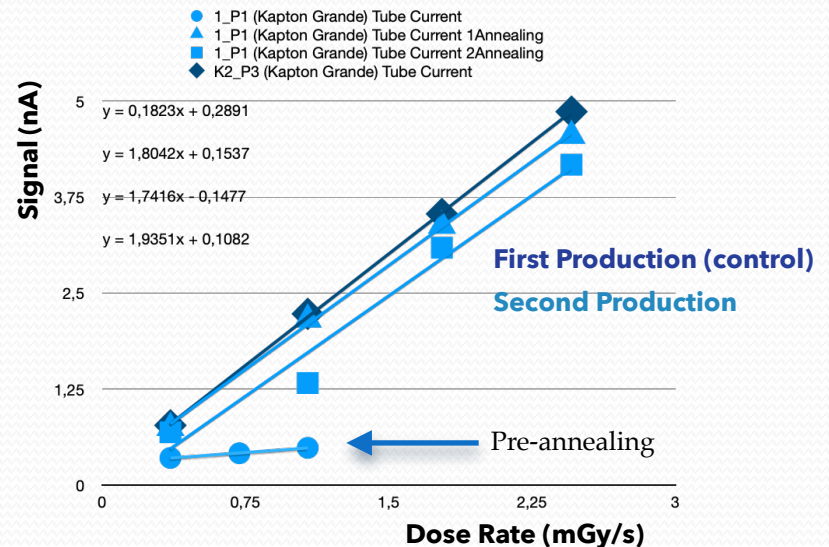


# Annealing effect

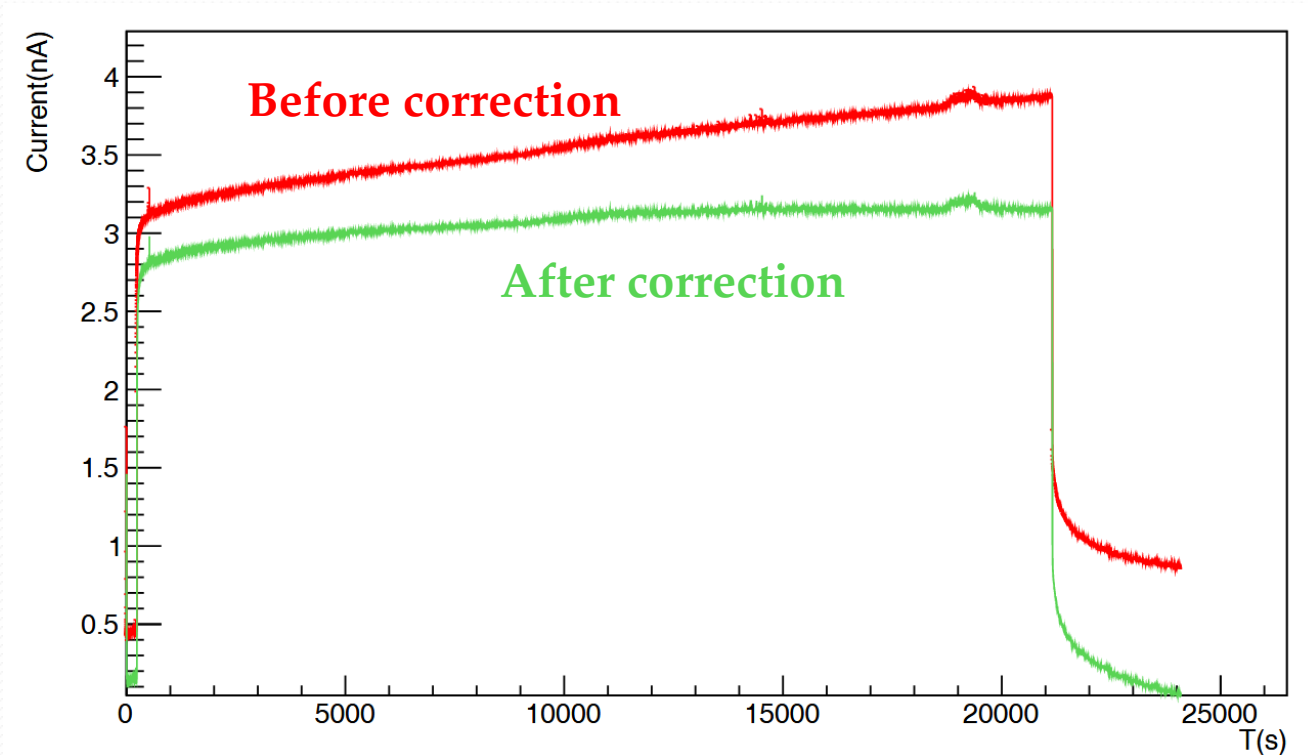


**X-rays Exposure** for sensitivity measure and homogeneity of the batch

**Sensors** are annealed (ones at 100°C for 12h) to match the performances of the batch

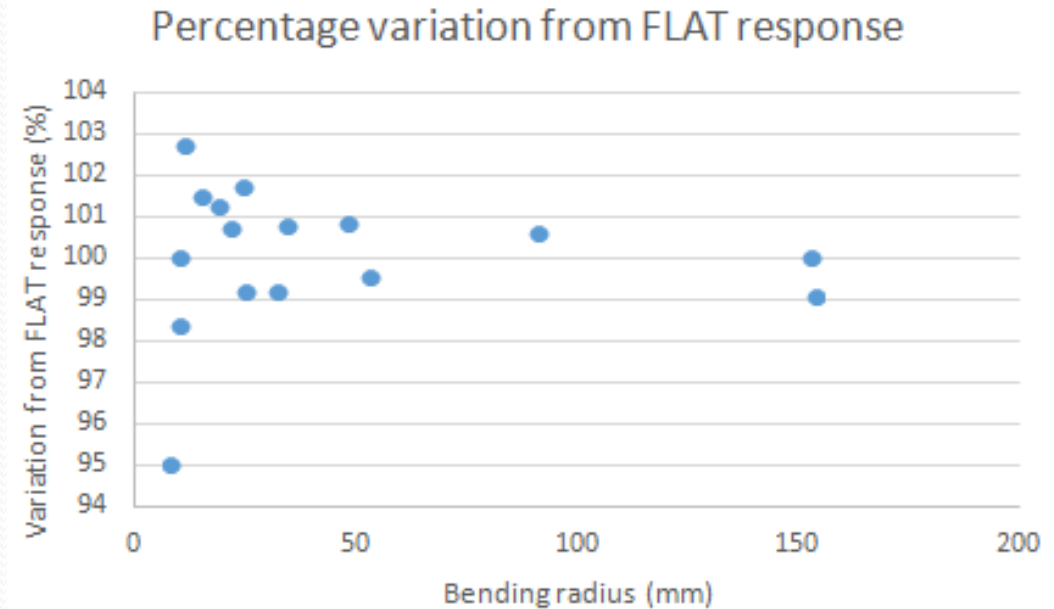
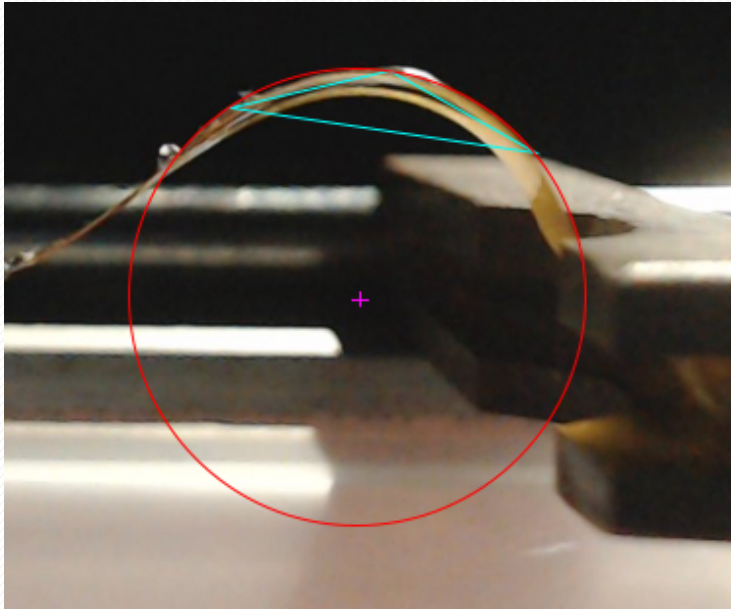


# Long term stability



- **5x5 mm<sup>2</sup>** device irradiated for **~6h** (dose rate of 0.4 cGy/s, 40 kV tube bias voltage)
- **linear extrapolation** between the dark current before and after irradiation-> **complete trend correction**

# Flexibility test (Australian WG)



- Detector is **glued** on a flexible **Polyimide PCB** support
- Deviation from the flat response is **below 3%**
- Little difference between **flat to bend** and **bend to flat (relaxation)** response

# Conclusions and future plans

- We have initiated the development of a:Si-H flexible devices for flux measurement for beam monitoring applications, SEP flux evaluation, personal dosimetry, neutron detection.
- P-i-n prototype devices successfully fabricated on PI and characterized
- Future plans include:
  - Flux measurements on proton and electron beam of prototypes
  - Fabrication and characterization of new thicker p-i-n and CSC devices
  - Further radiation damage tests



# Backup



# Current response and dose rate (x-rays) linearity

	Device Area (mm <sup>2</sup> )	Bias Voltage (V)	Dosimetric sensitivity (nC/cGy)	Regression coefficient R
Large	5x5	0	0.367	0.99999
		2	1.283	0.99991
		4	1.900	0.99975
		6	2.505	0.99972
		8	3.027	0.99926
Small	2x2	1	0.137	0.99878
		4	0.335	0.99961
		8	0.540	0.99881

Detector type and bias	Pre-rad Sensitivity (nC/cGy)	Sensitivity after irradiation (nC/cGy)	Sensitivity after 12h annealing (nC/cGy)	Sensitivity after 24h annealing (nC/cGy)
CSC at 30V bias	$11.1 \pm 0.3$	$5.0 \pm 0.1$	$6.5 \pm 0.2$	$7.2 \pm 0.2$
CSC at 0V bias	$0.86 \pm 0.03$	$0.10 \pm 0.02$	$0.24 \pm 0.02$	$0.30 \pm 0.02$
P-i-n diode at 60V	$2.39 \pm 0.09$	$1.13 \pm 0.08$	$3.0 \pm 0.1$	-

# The HASPIDE collaboration

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# Displacement damage on a 30 $\mu\text{m}$ a-Si:H planar detector

